SN54150, SN54151A, SN54LS151, SN54S151, SN74150, SN74151A, SN74LS151, SN74S151 DATA SELECTORS/MULTIPLEXERS

- '150 Selects One-of-Sixteen Data Sources
- Others Select One-of-Eight Data Sources
- All Perform Parallel-to-Serial Conversion
- All Permit Multiplexing from N Lines to One Line
- Also For Use as Boolean Function Generator
- Input-Clamping Diodes Simplify System Design
- Fully Compatible with Most TTL Circuits

ТҮРЕ	TYPICAL AVERAGE PROPAGATION DELAY TIME DATA INPUT TO W OUTPUT	TYPICAL POWER DISSIPATION
'150	13 ns	200 mW
ʻ151A	8 ns	145 mW
' LS1 51	13 ns	30 mW
'S151	4.5 ns	225 mW

description

These monolithic data selectors/multiplexers contain full on-chip binary decoding to select the desired data source. The '150 selects one-of-sixteen data sources; the '151A, 'LS151, and 'S151 select one-of-eight data sources. The '150, '151A, 'LS151, and 'S151 have a strobe input which must be at a low logic level to enable these devices. A high level at the strobe forces the W output high, and the Y output (as applicable) low.

The '150 has only an inverted W output; the '151A, 'LS151, and 'S151 feature complementary W and Y outputs.

The '151A and '152A incorporate address buffers that have symmetrical propagation delay times through the complementary paths. This reduces the possibility of transients occurring at the output(s) due to changes made at the select inputs, even when the '151A outputs are enabled (i.e., strobe low).

-								
	DECE	MBER	1972	-RE\	/ISED	MARC	H 198	Į
								-

SN54150 J . SN74150	
(TOP)	
E7 [1]	Z4 VCC
E6 [] 2	23 E8
E0 [] 2 E5 [] 3	23 E9
E 4 □ 4	21 E10
E3 []5	20 E11
E2 []6	19 E12
E1 17	18 E13
E La G Da	
W [] 10	15 A
GND [12	_13 □ C
SN54151A, SN54LS151, SN54	
SN74151A	
SN74LS151, SN74S151	
	/IEW)
D3 🛛 1 🗸	16 VCC
D2 🗍 2	15 🗋 D4
D1 🔲 3	14 🗋 D5
D0 🗍 4	13 D6
Y 🗖 5	12 D7
₩ 🗍 6	11 🗍 A
ច្បីរ	10 8
	эПс
4	
SN54LS151, SN54S1	51 FK PACKAGE
(TOP V	IEW)
	о С
N D D D D D D D D D D D D D D D D D D D	D 4C
	20 19
	18 D5
D0 [] 5	17UD6
Y D 7	15 D7
WUB	14 U A
	12 13
ျဖ ရ ပွ	Um
Z Z U	

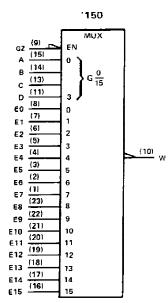
NC - No internal connection

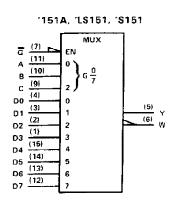
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Taxas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



SN54150, SN54151A, SN54LS151, SN54S151, SN74150, SN74151A, SN74LS151, SN74S151 DATA SELECTORS/MULTIPLEXERS

logic symbols[†]





[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are D, J, N, and W packages.

		FUI	NCTI	ON TABL	E
		IN	PUT	5	OUTPUT
[SEL	ECT		STROBE	
D	С	в	A	Ğ	W
х	X	х	х	н	н
L	L	L	L	L	ĒÕ
L	L	L	н	L	E1
L	L	H	L	L	E2
L	L	н	н	L	Ē3
L	н	L	L	L	Ē4
L	н	L	H	L	E5
L	н	н	L	L	E6
L	н	н	н	L	Ē7
н	L	L	L	L	68
н	L	L	H	L	Ē9
н	L	н	L	L	E10
н	L	н	н	L	E11
н	н	L	L	L	E12
н	н	L	н	L	E13
н	н	н	L	L	E14
н	н	н	н	L	E15

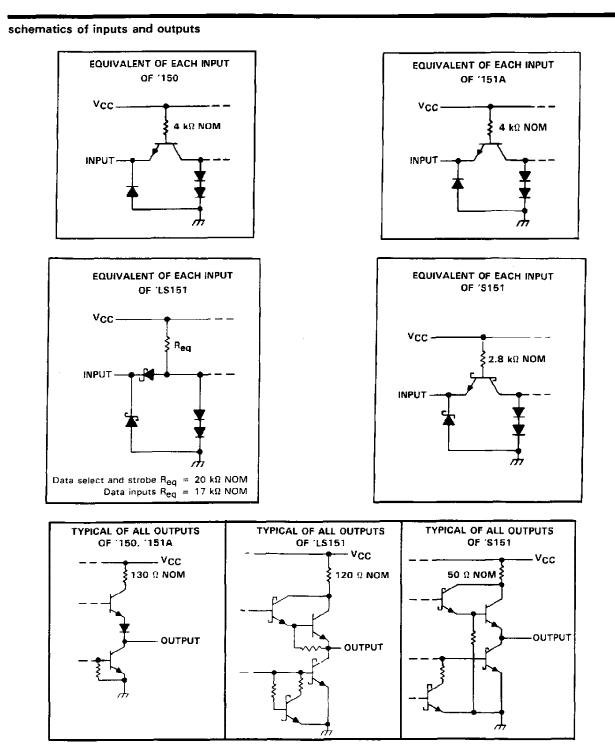
'150

151A, LS151, S151 FUNCTION TABLE

	H	VPUT	rs	OUT	PUTS								
s	ELEC	т	STROBE		w								
С	8	A	Ğ	¥	**								
X	х	X	н	L	н								
L	L	L	L	DO	00								
L	L	н	L	D1	D1								
L	н	Ł	L	D2	D2								
L	н	н	L	D3	D3								
н	L	L	L	D4	D4								
н	L	н	L	D5	D5								
н	н	L	L	D6	D6								
н	н	н	L	D7	D7								



SN54150, SN54151A, SN54LS151, SN54S151 SN74150, SN74151A, SN74LS151, SN74S151 DATA SELECTORS/MULTIPLEXERS



TEXAS V INSTRUMENTS

SN54150, SN54151A, SN74150, SN74151A DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

		SN54'			SN74'		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-800			-800	μA
Law-level output current, IOL			16			16	mΑ
Operating free-air temperature, TA	-55		125	0		70	Ċ

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDIT	uquat	′150				'151A		
	PARAMETER	IEST CONDIT		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	UNIT
VIH	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.8			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN, I _I =	-8 mA		· · ·	- 1.5			-1.5	v
∨он	High-level output voltage	$V_{CC} = MIN, V_{IH}$ $V_{IL} = 0.8 V, I_{OH}$	1	2.4	3.4		2.4	3.4		v
V _{OL}	Low-level output voltage	$V_{CC} = MIN, V_{IH}$ $V_{IL} = 0.8 V, I_{OL}$			0.2	0.4		0.2	0.4	v
4	Input current at maximum input voltage	$V_{CC} = MAX, V_{I} =$	= 5.5 V			1			1	mA
ЧH	High-level input current	$V_{CC} = MAX, V_{I} =$	= 2.4 V			40			40	μA
hL	Low-level input current	$V_{CC} = MAX, V_{I} =$	= 0.4 V			-1.6			-1.6	mA
	a t		SN54'	- 20		- 55	- 20		- 55	
los	Short-circuit output current ^s	V _{CC} = MAX	SN74'	- 18		- 55	- 18		- 55	mA
'cc	Supply current	VCC = MAX, See	Note 3		40	68		29	48	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type. ⁴ All typical values at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. ⁵ Not more than one output of the '151A should be shorted at a time.

NOTE 3: ICC is measured with the strobe and data select inputs at 4.5 V, all other inputs and outputs open.

switching characteristics, VCC = 5 V, TA = 25°C

our contract	FROM	то	TEST		'150			151/	A,	
PARAMETER	(INPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN	ТҮР	MAX	
^t PLH	A, B, or C	Y						25	38	
^t PHL	(4 levels)	,						25	38	- 115
tPLH	A, B, C, or D (3 levels)	W			23	35	_	17	26	ns
^t PHL					22	33		19	30	
τ Ρ ŁΗ	Strobe G	Y	С _L = 15 рF,					21	33	ns
^t PHL	Strobe G							22	33	1.13
^t PLH	Strobe G	w	See Note 4 j		15.5	24		14	21	
^t PHL	Strobe G	~~			21	30		15	23	ns
tPLH	D0 thru D7	Y						13	20	
τρητ		Ŧ						18	27	ns
tPLH	E0 thru E15, or	w			8.5	14		8	14	
^t PHL	D0 thru D7	**			13	20		8	14	ns

\$ tpLH = propagation delay time, low-to-high-level output tpHL = propagation delay time, high-to-low-level output NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

	s	SN54LS151			SN74LS151			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, VCC	4.5	5	b,b	4.75	5	5.25	Y	
High-level output current, IOH			-400			-400	μA	
Low-level output current, IOL			4			8	mA	
Operating free-air temperature, T _A	5		125	0		70	C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITIONS [†]	s	SN54LS151			N74LS1	51	
	PARAMETER	TEST CONDITIONS'	MIN	τγ₽‡	MAX	MIN	TYP [‡]	MAX	UNIT
ViH	High-level input voltage		2			2			v
VIL	Low-level input voltage		1		0.7			0.B	V
VIK	Input clamp voltage	$V_{CC} = MIN$, $I_{f} = -18 \text{ mA}$			- 1.5			-1.5	V
∨он	High-level output voltage	$V_{CC} = MIN, V_{IH} = 2 V,$ $V_{IL} = V_{IL}max, I_{OH} = -400 \ \mu A$	2.5	3,4		2.7	3.4		v
		$V_{CC} = MIN, V_{IH} = 2V, I_{OL} = 4 mA$		0.25	0.4		0.25	0.4	
VOL	Low-level output voltage	VIL = VILmax					0.35	0.5	V
ł	Input current at maximum input voltage	$V_{CC} = MAX, V_{\uparrow} = 7 V$			0.1			0.1	mA
Чн	High-level input current	V _{CC} = MAX, V ₁ = 2.7 V	1		20			20	μA
կլ	Low-level input current	$V_{CC} = MAX, V_I = 0.4 V$			-0.4			-0.4	mA
los	Short-circuit output current§	V _{CC} = MAX	- 20		- 100	- 20		- 100	mA
lcc	Supply current	V _{CC} = MAX, Outputs open, All inputs at 4.5 V		6.0	10		6.0	10	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type. [‡] All typical values are at V_{CC} = 5 V, T_A = 25 °C. [§] Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A 25 °C

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN TYP	MAX	דואט	
^t PLH	A, B, or C	Y		27	43		
^t PHL	(4 levels)	r		18	30	ns	
^t PLH	A, B, or C	W	1	14	23		
tPHL	(3 levels)	¥¥	 Сц = 15 рF.	20	32	ns	
^t PLH	Strobe G	Y		26	42		
tPHL		T		20	32	2 115	
^t PLH	Strobe G	w	R _L – 2 kΩ, See Note 4	15	24		
tPHL	SHODE G	vv	VV See Note 4	18	30	ns	
tplh			1	20	32		
tPHL	- Any D	Y		16	26	ns	
^t PLH	A	w		13	21		
tPHL	- Any D	vv		12	20	05	



SN54S151, SN74S151 DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

	\$	SN54S151				SN74S151			
	MIN	NOM	MAX	MIN	NOM	MAX			
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V		
High-level output current, IOH			-t			-1	mA		
Low-level output current, IOL			20			20	mΑ		
Operating free-air temperature, TA	55		125	0		70	°C		

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]		MIN	ТҮР‡	MAX	UNIT
ViH	High-level input voltage			2			v
VIL	Low-level input voltage					0.8	V
Vik	Input clamp voltage	$V_{CC} = MIN, I_I = -18 \text{ mA}$				-1.2	v
VOH		$V_{CC} = MIN, V_{IH} = 2V,$	SN54S151	2.5	3.4		
чон	High-level output voltage	VIL = 0.8 V, I _{OH} = -1 mA	SN74S151	2.7	3.4		v
V		VCC = MIN, V(H = 2 V,	A			0.5	v
VOL	Low-level output voltage	VIL = 0.8 V, IOL = 20 mA			0.5	v	
4	Input current at maximum input voltage	V _{CC} = MAX, V ₁ = 5.5 V				1	mA
ЧĤ	High-level input current	V _{CC} = MAX, V _I = 2.7 V				50	μA
ΊL	Low-level input current	V _{CC} - MAX, VI = 0.5 V				-2	ΜM
los	Short-circuit output current §	V _{CC} = MAX		-40		-100	mA
lcc	Supply current	V _{CC} = MAX, All inputs at 4.5 V, All outputs open			45	70	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

type. ‡All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. §Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

switching characteristics. VCC = 5 V. TA 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	МАХ	UNIT
^t PLH	A, B, or C	Y			12	18	
^t PHL	(4 leveis)	Ĩ	1		12	18	ns
t p lh	A, B, or C	W	-		10	15	ns
[†] PHL	(3 levels)		CL = 15 pF, - RL = 280 kΩ, See Note 4		9	13.5	
tPLH	Any D	Y			8	12	ns 7 ns 7 ns 7 ns 7 ns 8 ns 8 ns
^t PHL	Any D				8	12	
tPLH	- Any D				4.5	7	
^t PHL		V¥			4.5	7	
tplH	Strobe G	Y			11	16.5	
tphL		Ť	ĺ		12	18	
tPLH	- Strobe G	w]		9	13	
tPHL		44			8.5	12	กร





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
76010012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	76010012A SNJ54LS 151FK	Samples
7601001EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
7601001EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
JM38510/07901BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07901BEA	Samples
JM38510/07901BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07901BFA	Samples
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples
JM38510/30901BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
JM38510/30901BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
M38510/07901BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07901BEA	Samples
M38510/07901BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07901BFA	Samples
M38510/30901B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples
M38510/30901B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901B2A	Samples
M38510/30901BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
M38510/30901BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BEA	Samples
M38510/30901BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
M38510/30901BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30901BFA	Samples
SN54LS151J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS151J	Samples
SN54LS151J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS151J	Samples
SN54S151J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S151J	Samples
SN74LS151D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS151	Samples
SN74LS151N	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151N	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151NE4	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151NE4	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS151N	Samples
SN74LS151NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SN74LS151NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS151	Samples
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	76010012A SNJ54LS 151FK	Samples
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	76010012A SNJ54LS 151FK	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS151J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
SNJ54LS151J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7601001EA SNJ54LS151J	Samples
SNJ54S151J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S151J	Samples
SNJ54S151W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S151W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54LS151, SN74LS151 :

• Catalog : SN74LS151

Military : SN54LS151

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

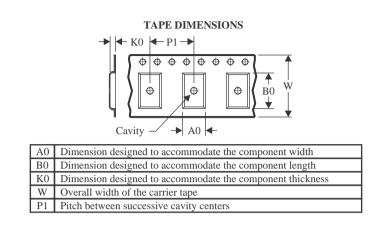


Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*A	l dimensions are nominal												
	Device	•	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74LS151DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
	SN74LS151NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

9-Aug-2022



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS151DR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS151NSR	SO	NS	16	2000	356.0	356.0	35.0

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

All dimensions are nominal		<u>, </u>						
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
76010012A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/07901BFA	W	CFP	16	1	506.98	26.16	6220	NA
JM38510/30901B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/30901BFA	W	CFP	16	1	506.98	26.16	6220	NA
M38510/07901BFA	W	CFP	16	1	506.98	26.16	6220	NA
M38510/30901B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/30901BFA	W	CFP	16	1	506.98	26.16	6220	NA
SN74LS151D	D	SOIC	16	40	507	8	3940	4.32
SN74LS151N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS151N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS151NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS151NE4	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS151FK	FK	LCCC	20	1	506.98	12.06	2030	NA

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



4211283-4/E 08/12

D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) –16x0,55 -14x1,27 -14x1,27 16x1,50 5,40 5.40 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 .55 Example 1. Solder Mask Opening (See Note E) -0,07 All Around

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP2-F16



FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



NS0016A



PACKAGE OUTLINE

SOP - 2.00 mm max height

SOP



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- Per ASME Y14.5M.
 This drawing is subject to change without notice.
 This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



NS0016A

EXAMPLE BOARD LAYOUT

SOP - 2.00 mm max height

SOP



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



NS0016A

EXAMPLE STENCIL DESIGN

SOP - 2.00 mm max height

SOP



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



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